

# RoHS



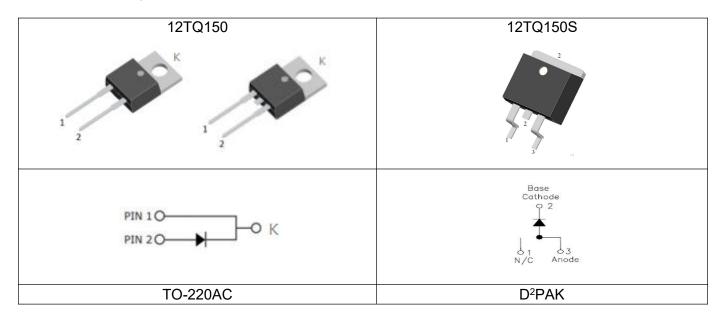
### 12TQ150/S SCHOTTKY RECTIFIER

#### **Features**

- 175℃ T<sub>J</sub> operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- · Terminals finish: Tin Lead-free plated
- This is a Pb Free Device
- . All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

#### **Applications**

- Switching power supply
- · Redundant power subsystems
- Converters
- Free-Wheeling diodes
- Reverse battery protection



#### Maximum Ratings@Tc=25°C unless otherwise specified

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	150	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	50% duty cycle @Tc=116°C, rectangular wave form	15	Α
Peak One Cycle Non-Repetitive Surge Current	I <sub>FSM</sub>	8.3ms, Half Sine pulse	276	Α

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#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V <sub>F1</sub>	@ 15A, Pulse, T <sub>J</sub> = 25 °C	0.82	0.86	V
	V <sub>F2</sub>	@ 15A, Pulse, T <sub>J</sub> = 125 °C	0.64	0.70	V
Reverse Current *	I <sub>R1</sub>	$@V_R = \text{rated } V_R$ $T_J = 25 \ ^{\circ}C$	0.001	1.0	mA
	I <sub>R2</sub>	$@V_R = \text{rated } V_R$ $T_J = 125 ^{\circ}C$	0.2	7	mA
Junction Capacitance	Ст	$@V_R = 5V, T_C = 25 \degree C$ $f_{SIG} = 1MHz$	383	500	pF
Series Inductance	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/µs

 $<sup>^*</sup>$  Pulse width < 300  $\mu$ s, duty cycle < 2%

### **Thermal-Mechanical Specifications:**

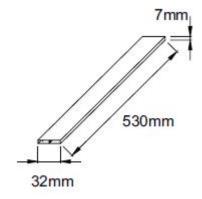
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R <sub>θ</sub> JC	DC operation	2.0	°C/W
Typical Thermal Resistance Case to Heat Sink	R <sub>θCS</sub>	Mounting surface, smooth and greased(only for TO-220)	0.50	°C/W
Case Style	TO-220AC D <sup>2</sup> PAK			

### **Tube Specification**

Device	Package	Weight	Shipping
12TQ150	TO-220AC	1.8g	50pcs / tube
12TQ150S	D² PAK	1.85g	800pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

# **Tube Specification(TO-220AC)**



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### **Ratings and Characteristics Curves**

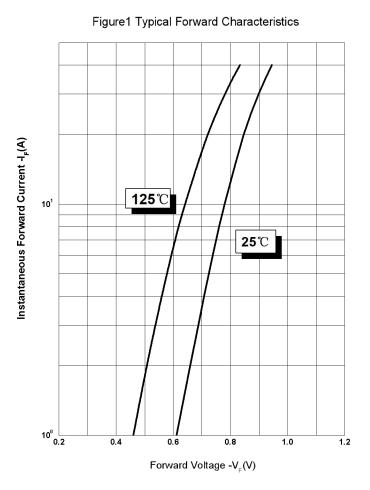
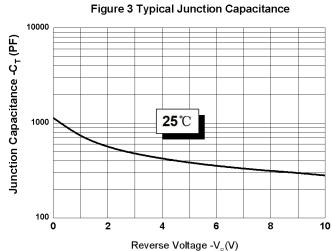


Figure 2 Typical Reverse Characteristics

10<sup>3</sup>
10<sup>2</sup>
10<sup>3</sup>
10<sup>4</sup>
10<sup>2</sup>
25°C
125°C
Reverse Voltage -V<sub>R</sub>(V)



<sup>•</sup> China - Germany - Korea - Singapore - United States •

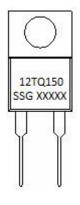
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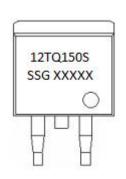






# **Marking Diagram**





#### Where XXXXX is YYWWL

12 = Forward Current (12A) TQ = Device Type 150 = Reverse Voltage (150V)

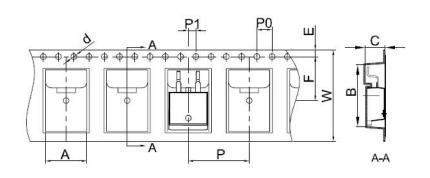
S = Package type SSG = SSG

YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

### Carrier Tape Specification D<sup>2</sup>PAK



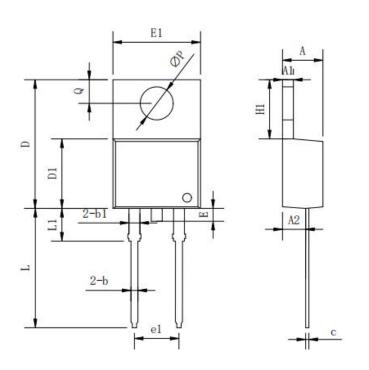
Symbol	Millimeters		
Зунион	Min.	Max.	
А	10.70	10.90	
В	16.03	16.23	
С	5.11	5.31	
d	1.45	1.65	
E	1.65	1.85	
F	11.40	11.60	
P0	3.90	4.10	
Р	15.90	16.10	
P1	1.90	2.10	
W	23.90	24.30	





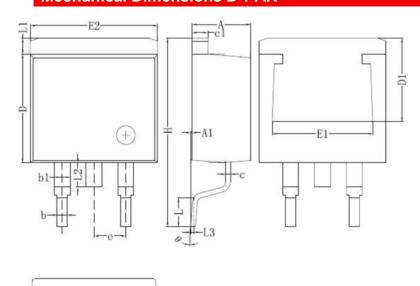


### **Mechanical Dimensions TO-220AC**



Symbol	Dimensions in millimeters		
- <b>,</b>	Min.	Typical	Max.
Α	3.56	-	4.83
A1	0.51	-	1.4
A2	2.03	-	2.92
b	0.38	-	1.02
b1	1.14	-	1.78
С	0.31	-	0.61
D	14.22	-	16.51
D1	8.38	-	9.42
E	-	-	1.78
E1	9.65	10.16	10.67
e1	-	5.08	-
H1	5.84	-	6.86
L	12.7	-	14.73
L1	-	-	6.35
ФР	-	3.56	-
Q	2.54	-	3.43

# Mechanical Dimensions D<sup>2</sup>PAK



O makad	Dimensions in millimeters		
Symbol	Min.	Max.	
Α	4.06	4.83	
A1	0	0.26	
b	0.51	0.99	
b1	1.14	1.78	
С	0.31	0.74	
c1	1.14	1.65	
D	8.38	9.65	
D1	6.4		
E1	6.22		
E2	9.65	10.67	
е	2.54BSC		
Н	14.6	15.88	
L	1.78	2.8	
L1	-	1.68	
L2	-	2.2	
L3	0.255BSC		
Θ	0	8°	

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